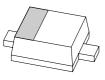
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# PESD5V0S1UJ; PESD12VS1UJ

Unidirectional ESD protection for transient voltage suppression

Rev. 01 — 3 June 2009

**Product data sheet** 

## 1. Product profile

### 1.1 General description

Unidirectional ElectroStatic Discharge (ESD) protection diodes in a very small Surface-Mounted Device (SMD) plastic package designed to protect one signal line from the damage caused by ESD and transient overvoltage.

#### Table 1.Product overview

Type number	Package		Configuration	
	NXP	JEITA		
PESD5V0S1UJ	SOD323F	SC-90	single	
PESD12VS1UJ				

ESD protection up to 30 kV

IEC 61000-4-2; level 4 (ESD)

AEC-Q101 qualified

Communication systems

Portable electronics

IEC 61000-4-5 (surge); I<sub>PP</sub> = 47 A

Medical and industrial equipment

### **1.2 Features**

- Transient Voltage Suppression (TVS) protection of one line
- Max. peak pulse power: P<sub>PP</sub> = 890 W
- Low clamping voltage: V<sub>CL</sub> = 19 V
- Low leakage current: I<sub>RM</sub> = 300 nA

### **1.3 Applications**

- Computers and peripherals
- Audio and video equipment
- Cellular handsets and accessories
- 1.4 Quick reference data

#### Table 2. Quick reference data

 $T_{amb} = 25 \,^{\circ}C$  unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>RWM</sub>	reverse standoff voltage					
	PESD5V0S1UJ		-	-	5	V
	PESD12VS1UJ		-	-	12	V
C <sub>d</sub>	diode capacitance	$f = 1 \text{ MHz}; V_R = 0 \text{ V}$				
	PESD5V0S1UJ		-	480	530	pF
	PESD12VS1UJ		-	160	180	pF



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#### Unidirectional ESD protection for transient voltage suppression

## 2. Pinning information

Table 3.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	cathode	<u>[1]</u>	
2	anode		1 2 006aaa152

[1] The marking bar indicates the cathode.

## 3. Ordering information

Table 4.         Ordering information						
Type number Package						
	Name	Description	Version			
PESD5V0S1UJ	SC-90	plastic surface-mounted package; 2 leads	SOD323F			
PESD12VS1UJ						

### 4. Marking

Table 5. Marking codes	
Type number	Marking code
PESD5V0S1UJ	1Q
PESD12VS1UJ	1R

### 5. Limiting values

#### Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

		0, (	,		
Symbol	Parameter	Conditions	Min	Max	Unit
P <sub>PP</sub>	peak pulse power	$t_p = 8/20 \ \mu s$	[1][2]		
	PESD5V0S1UJ		-	890	W
	PESD12VS1UJ		-	600	W
I <sub>PP</sub>	peak pulse current	$t_p = 8/20 \ \mu s$	[1][2]		
	PESD5V0S1UJ		-	47	А
	PESD12VS1UJ		-	22.5	А

#### Unidirectional ESD protection for transient voltage suppression

#### Table 6.Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[3]</u>	420	mW
			<u>[4]</u> _	720	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Non-repetitive current pulse 8/20 µs exponential decay waveform according to IEC 61000-4-5.

[2] Soldering point of cathode tab.

[3] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

#### Table 7.ESD maximum ratings

 $T_{amb} = 25 \circ C$  unless otherwise specified.

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>ESD</sub> electrostatic discharge voltage	electrostatic discharge voltage	IEC 61000-4-2 (contact discharge)	<u>[1]</u>	-	30	kV
	machine model		-	400	V	
		MIL-STD-883 (human body model)		-	16	kV

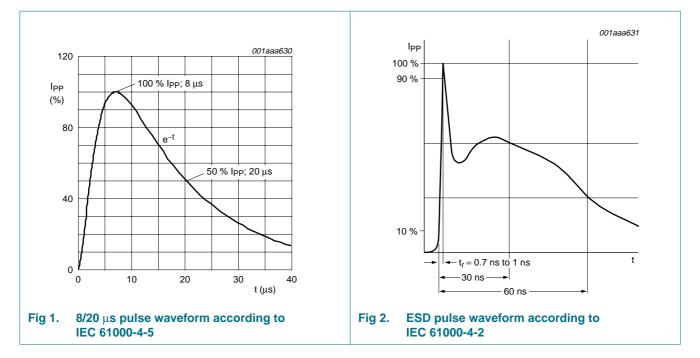
[1] Device stressed with ten non-repetitive ESD pulses.

#### Table 8. ESD standards compliance

Standard	Conditions
IEC 61000-4-2; level 4 (ESD)	> 15 kV (air); > 8 kV (contact)
MIL-STD-883; class 3 (human body model)	> 4 kV



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### 6. Thermal characteristics

Table 9.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	R <sub>th(j-a)</sub> thermal resistance from junction to ambient	in free air	<u>[1]</u> _	-	290	K/W
			[2] _	-	170	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		<u>[3]</u> _	-	35	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

[3] Soldering point of cathode tab.



Unidirectional ESD protection for transient voltage suppression

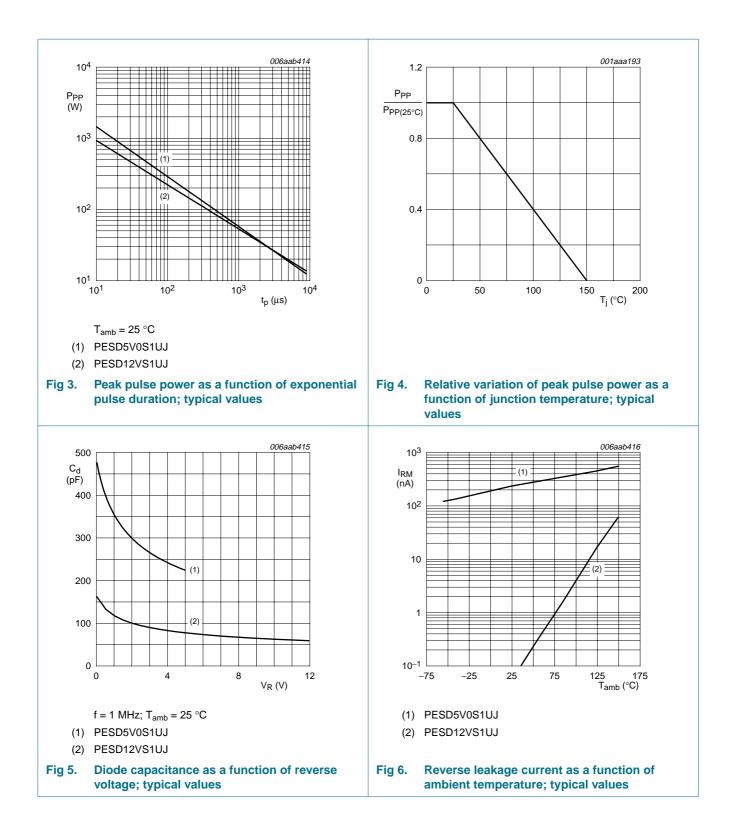
## 7. Characteristics

Symbol	Parameter	Conditions	Mir	n Typ	Мах	Unit
V <sub>RWM</sub>	reverse standoff voltage					
	PESD5V0S1UJ		-	-	5	V
	PESD12VS1UJ		-	-	12	V
I <sub>RM</sub>	reverse leakage current					
	PESD5V0S1UJ	$V_{RWM} = 5 V$	-	0.3	4	μΑ
	PESD12VS1UJ	$V_{RWM} = 12 V$	-	< 1	100	nA
V <sub>BR</sub>	breakdown voltage	$I_R = 5 \text{ mA}$				
	PESD5V0S1UJ		6.2	6.8	7.3	V
	PESD12VS1UJ		13.	3 14.5	15.75	V
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 0 V				
	PESD5V0S1UJ		-	480	530	pF
	PESD12VS1UJ		-	160	180	pF
V <sub>CL</sub>	clamping voltage		<u>[1]</u>			
	PESD5V0S1UJ	I <sub>PP</sub> = 47 A	-	-	19	V
		I <sub>PP</sub> = 25 A	-	-	13.5	V
		I <sub>PP</sub> = 5 A	-	-	9.8	V
	PESD12VS1UJ	I <sub>PP</sub> = 22.5 A	-	-	27	V
		I <sub>PP</sub> = 15 A	-	-	23.5	V
		$I_{PP} = 5 A$	-	-	19	V
r <sub>dif</sub>	differential resistance	$I_R = 5 \text{ mA}$				
	PESD5V0S1UJ		-	2	100	Ω
	PESD12VS1UJ		-	5	100	Ω

[1] Non-repetitive current pulse 8/20 µs exponential decay waveform according to IEC 61000-4-5.



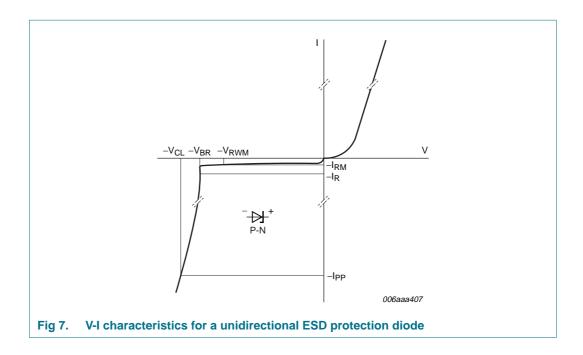
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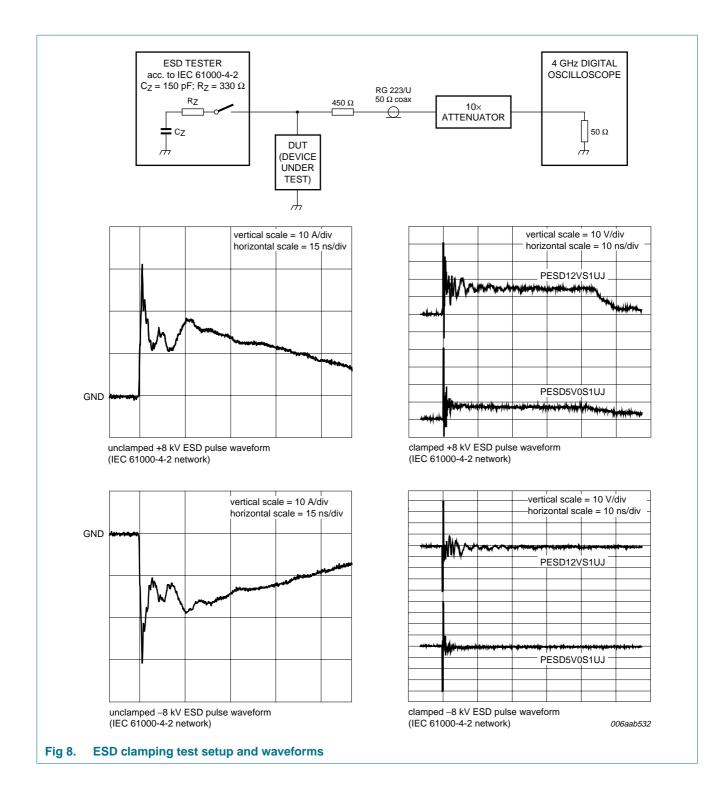


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#### Unidirectional ESD protection for transient voltage suppression



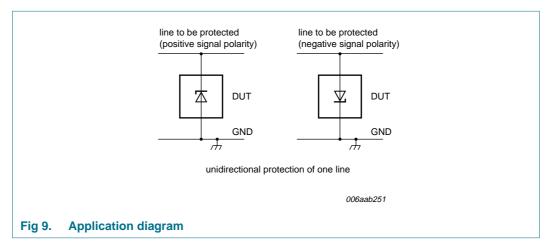


#### Unidirectional ESD protection for transient voltage suppression

### 8. Application information

PESD5V0S1UJ and PESD12VS1UJ are designed for the protection of one unidirectional data or signal line from the damage caused by ESD and transient overvoltage. The devices may be used on lines where the signal polarities are either positive or negative with respect to ground.

The PESD5V0S1UJ provides a surge capability of 890 W and the PESD12VS1UJ provides a surge capability of 600 W per line for an 8/20  $\mu$ s waveform.



#### Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD and Electrical Fast Transient (EFT). The following guidelines are recommended:

- 1. Place the device as close to the input terminal or connector as possible.
- 2. The path length between the device and the protected line should be minimized.
- 3. Keep parallel signal paths to a minimum.
- 4. Avoid running protected conductors in parallel with unprotected conductors.
- 5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
- 6. Minimize the length of the transient return path to ground.
- 7. Avoid using shared transient return paths to a common ground point.
- 8. Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.



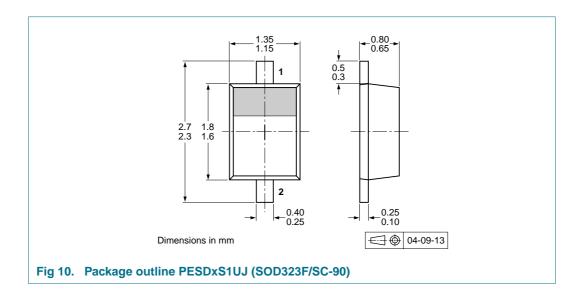
#### Unidirectional ESD protection for transient voltage suppression

### 9. Test information

### 9.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

### **10. Package outline**



### **11. Packing information**

#### Table 11. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

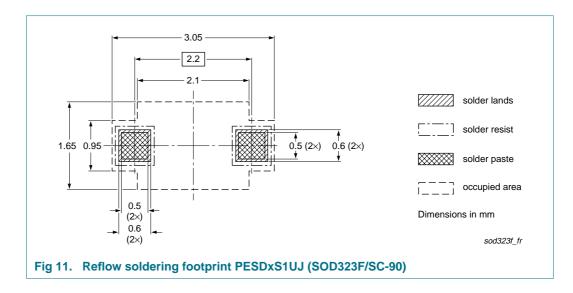
Type number	Package	Description		Packing quantity	
				3000	10000
PESD5V0S1UJ	SOD323F	4 mm pitch, 8 mm tape and reel		-115	-135
PESD12VS1UJ					

[1] For further information and the availability of packing methods, see Section 15.



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## 12. Soldering





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## 13. Revision history

Table 12.         Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
PESD5V0S1UJ_PESD12VS1UJ_1	20090603	Product data sheet	-	-



Unidirectional ESD protection for transient voltage suppression

## 14. Legal information

### 14.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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PESD5V0S1UJ\_PESD12VS1UJ\_1

**Product data sheet** 



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